

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Seungmin LEE</td> <td>08/13/2013</td> </tr> <tr> <td>Hakseong KIM</td> <td>08/13/2013</td> </tr> <tr> <td>Hanbyul SEO</td> <td>08/13/2013</td> </tr> </tbody> </table>		Name	Execution Date	Seungmin LEE	08/13/2013	Hakseong KIM	08/13/2013	Hanbyul SEO	08/13/2013
Name	Execution Date								
Seungmin LEE	08/13/2013								
Hakseong KIM	08/13/2013								
Hanbyul SEO	08/13/2013								
RECEIVING PARTY DATA									
Name:	LG ELECTRONICS INC.								
Street Address:	20, Yeouido-dong, Yeongdeungpo-gu								
City:	Seoul								
State/Country:	KOREA, REPUBLIC OF								
Postal Code:	150-721								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14003420</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14003420				
Property Type	Number								
Application Number:	14003420								
CORRESPONDENCE DATA									
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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NAME OF SUBMITTER:	BRIAN MUKURIA								
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Date:	09/06/2013								
Total Attachments: 2 source=2013-09-06_ASSIGNMENT_0465-3955PUS1#page1.tif source=2013-09-06_ASSIGNMENT_0465-3955PUS1#page2.tif									

OP \$40.00 14003420

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR  
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No.: 14/003,420

Filed: September 5, 2013

Insert Name(s) of Inventor(s) ⇒ <sup>\*\*\*(Given Name FAMILY NAME (ALL CAPS))\*\*\*</sup>

WHEREAS, LEE, Seungmin, KIM, Hakseong and SEO, Hanbyul  
(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in:

Insert Title of Invention ⇒

**METHOD FOR TRANSMITTING UPLINK CONTROL INFORMATION IN A WIRELESS COMMUNICATION SYSTEM AND DEVICE FOR SAME**

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application)

Insert Date of Signing of Appln. ⇒

on August 13, 2013 ; and

Insert Name of Assignee ⇒

WHEREAS, LG ELECTRONICS INC.

Insert Address of Assignee ⇒

of 20, Yeouido-dong, Yeongdeungpo-gu, Seoul 150-721, Republic of Korea,

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

Check Box if Appropriate ⇒

in any foreign countries.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these presents does (do) sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

he undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

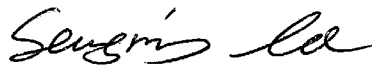
The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of (a) valid United States of America patent(s) or a grant of (a) valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

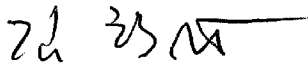
The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

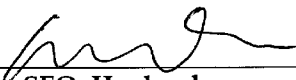
The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 2013. 8. 13 Name of Inventor   
(Signature) **LEE, Seungmin**

Date 2013. 8. 13 Name of Inventor   
(Signature) **KIM, Hakseong**

Date 2013. 8. 13 Name of Inventor   
(Signature) **SEO, Hanbyul**